TOSHIBA MOS DIGITAL INTEGRATED CIRCUIT SILICON GATE CMOS

524.288-WORD BY 8-BIT CMOS STATIC RAM

DESCRIPTION

The TC55V8512JI/FTI is a 4,194,304-bit high-speed static random access memory (SRAM) organized as 524,288 words by 8 bits. Fabricated using CMOS technology and advanced circuit techniques to provide high speed, it operates from a single 3.3 V power supply. Chip enable ($\overline{\text{CE}}$) can be used to place the device in a low-power mode, and output enable ($\overline{\text{OE}}$) provides fast memory access. This device is well suited to cache memory applications where high-speed access and high-speed storage are required. All inputs and outputs are directly LVTTL compatible. The TC55V8512JI/FTI is available in plastic 36-pin SOJ and 44-pin TSOP with 400mil width for high density surface assembly. The TC55V8512JI/FTI guarantees –40° to 85°C operating temperature so it is suitable for use in wide operating temperature system.

FEATURES

- Fast access time (the following are maximum values)
 TC55V8512JI/FTI-12:12 ns
 TC55V8512JI/FTI-15:15 ns
- Low-power dissipation (the following are maximum values)

| Cycle Time | 12 | 15 | 20 | 25 | ns |
|-----------------|-----|-----|-----|-----|----|
| Operation (max) | 180 | 150 | 140 | 120 | mA |

Standby:10 mA (both devices)

- Single power supply voltage of $3.3~V \pm 0.3~V$
- Fully static operation
- All inputs and outputs are LVTTL compatible
- Output buffer control using \overline{OE}
- Package:

SOJ36-P-400-1.27 (JI) (Weight: 1.35 g typ) TSOP II44-P-400-0.80 (FTI) (Weight: 0.45 g typ)

PIN ASSIGNMENT (TOP VIEW)

(TC55V8512JI)

36 PIN SOJ 44 PIN TSOP

| | NC |
|--|----|
|--|----|

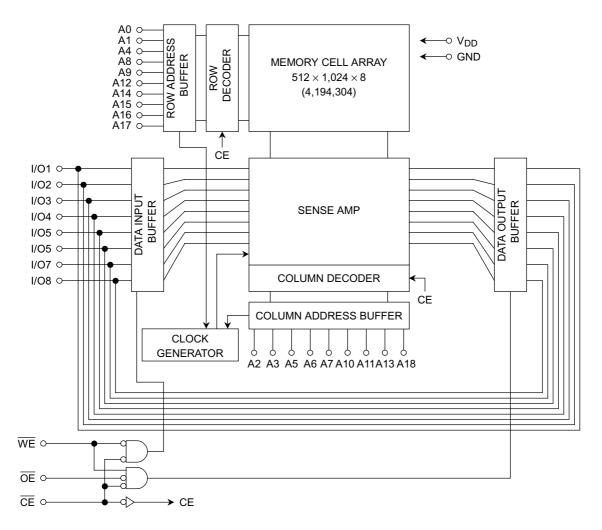
(TC55V8512FTI)

PIN NAMES

| A0 to A18 | Address Inputs | |
|--------------|---------------------|--|
| I/O1 to I/O8 | Data Inputs/Outputs | |
| CE | Chip Enable Input | |
| WE | Write Enable Input | |
| ŌĒ | Output Enable Input | |
| V_{DD} | Power (+3.3 V) | |
| GND | Ground | |
| NC | No Connection | |
| NU | Not Usable (Input) | |



BLOCK DIAGRAM



MAXIMUM RATINGS

| SYMBOL | RATING | VALUE | UNIT |
|---------------------|-------------------------------|----------------------------------|------|
| V_{DD} | Power Supply Voltage | -0.5 to 4.6 | V |
| V _{IN} | Input Terminal Voltage | −0.5* to 4.6 | V |
| V _{I/O} | Input/Output Terminal Voltage | −0.5* to V _{DD} + 0.5** | V |
| P _D | Power Dissipation | 1.4 | W |
| T _{solder} | Soldering Temperature (10s) | 260 | °C |
| T _{stg} | Storage Temperature | -65 to 150 | °C |
| T _{opr} | Operating Temperature | -40 to 100 | °C |

^{*: -1.5} V with a pulse width of 20% t_{RC} min (4 ns max)

DC RECOMMENDED OPERATING CONDITIONS (Ta = -40° to 85°C)

| SYMBOL | PARAMETER | MIN | TYP | MAX | UNIT |
|-----------------|----------------------|-------|-----|-------------------------|------|
| V_{DD} | Power Supply Voltage | 3.0 | 3.3 | 3.6 | V |
| V _{IH} | Input High Voltage | 2.0 | _ | V _{DD} + 0.3** | V |
| V _{IL} | Input Low Voltage | -0.3* | _ | 0.8 | V |

^{*: –1.0} V with a pulse width of 20% \cdot $t_{\mbox{\scriptsize RC}}$ min (4 ns max)

^{**:} V_{DD} + 1.5 V with a pulse width of 20% \cdot t_{RC} min (4 ns max)

^{**:} V_{DD} + 1.0 V with a pulse width of 20% t_{RC} min (4 ns max)



DC CHARACTERISTICS (Ta = -40° to 85°C, V_{DD} = 3.3 V \pm 0.3 V)

| SYMBOL | PARAMETER | TEST CONDITION | | MIN | TYP | MAX | UNIT |
|---------------------|---------------------------------------|--|----------------------------|-----------------------|-----|-----|------|
| I _{IL} | Input Leakage Current (Except NU pin) | V _{IN} = 0 to V _{DD} | | -1 | _ | 1 | μΑ |
| I _{LO} | Output Leakage Current | $\overline{CE} = V_{IH} \text{ or } \overline{WE} = V_{IL} \text{ or } \overline{OE} = V_{IH},$ $V_{OUT} = 0 \text{ to } V_{DD}$ | | -1 | _ | 1 | μΑ |
| | Input Current | V _{IN} = 0 to 0.8 V | | -1 | _ | 20 | |
| l _I (NU) | (NU pin) | V _{IN} = 0 to 0.2 V | | -1 | _ | 1 | μΑ |
| ., | Out and I link Walter | $I_{OH} = -2 \text{ mA}$ | | 2.4 | _ | | |
| V _{OH} | Output High Voltage | $I_{OH} = -100 \mu\text{A}$ | | V _{DD} – 0.2 | _ | _ | ., |
| ., | | I _{OL} = 2 mA | | _ | _ | 0.4 | V |
| V _{OL} | Output Low Voltage | I _{OL} = 100 μA | | _ | _ | 0.2 | |
| | | | t _{cycle} = 12 ns | _ | _ | 180 | |
| | On a matting of Command | $\overline{CE} = V_{IL}, I_{OUT} = 0 \text{ mA},$ | t _{cycle} = 15 ns | _ | _ | 150 | ^ |
| I _{DDO} | Operating Current | $\overline{OE} = V_{IH},$ Other Input = V_{IH}/V_{II} | t _{cycle} = 20 ns | _ | _ | 140 | mA |
| | | Othor mpac VIII/VIL | t _{cycle} = 25 ns | _ | _ | 120 | |
| I _{DDS1} | Ot a will be O would | CE = V _{IH} , Other Input = V _{IH} or V _{IL} | | _ | _ | 55 | |
| I _{DDS2} | Standby Current | $\overline{CE} = V_{DD} - 0.2 \text{ V}$, Other Input = V_{DD} - | - 0.2 V or 0.2 V | _ | _ | 10 | mA |

CAPACITANCE (Ta = 25°C, f = 1.0 MHz)

| SYMBOL | PARAMETER | TEST CONDITION | MAX | UNIT |
|------------------|--------------------------|-----------------------|-----|------|
| C _{IN} | Input Capacitance | V _{IN} = GND | 6 | pF |
| C _{I/O} | Input/Output Capacitance | $V_{I/O} = GND$ | 8 | pF |

Note: This parameter is periodically sampled and is not 100% tested.

OPERATING MODE

| MODE | CE | ŌĒ | WE | I/O1 to I/O8 | POWER |
|-----------------|----|----|----|----------------|------------------|
| Read | L | L | Н | Output | I _{DDO} |
| Write | L | * | L | Input | I _{DDO} |
| Outputs Disable | L | Н | Н | High Impedance | I _{DDO} |
| Standby | Н | * | * | High Impedance | I _{DDS} |

^{* :} Don't care

Note: The NU pin must be left unconnected or tied to GND or a voltage level of less than 0.8 V. You must not apply a voltage of more than 0.8 V to the NU.



<u>AC CHARACTERISTICS</u> (Ta = -40° to 85°C ^(See Note 1), $V_{DD} = 3.3 \text{ V} \pm 0.3 \text{ V}$)

READ CYCLE

| | | | TC55V8 | 512JI/FTI | | |
|------------------|---|-----|--------|-----------|-----|------|
| SYMBOL | BOL PARAMETER | | -12 | | 15 | UNIT |
| | | MIN | MAX | MIN | MAX | Ī |
| t _{RC} | Read Cycle Time | 12 | _ | 15 | _ | |
| t _{ACC} | Address Access Time | _ | 12 | _ | 15 | |
| t _{CO} | Chip Enable Access Time | _ | 12 | _ | 15 | |
| t _{OE} | Output Enable Access Time | _ | 6 | _ | 8 | |
| t _{OH} | Output Data Hold Time from Address Change | 3 | _ | 4 | _ | ns |
| t _{COE} | Output Enable Time from Chip Enable | 3 | _ | 4 | _ | |
| toee | Output Enable Time from Output Enable | 1 | _ | 1 | _ | |
| t _{COD} | Output Disable Time from Chip Enable | _ | 7 | _ | 8 | |
| t _{ODO} | Output Disable Time from Output Enable | _ | 7 | _ | 8 | |

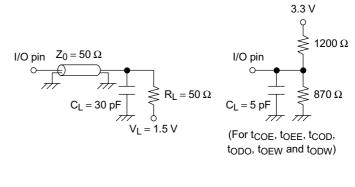
WRITE CYCLE

| | | | | | TC55V8512JI/FTI | | | |
|------------------|---------------------------------------|-----|-----|-----|-----------------|------|--|--|
| SYMBOL | BOL PARAMETER | | 12 | | 15 | UNIT | | |
| | | MIN | MAX | MIN | MAX | | | |
| t _{WC} | Write Cycle Time | 12 | _ | 15 | _ | | | |
| t _{WP} | Write Pulse Width | 8 | _ | 9 | _ | | | |
| t _{CW} | Chip Enable to End of Write | 10 | _ | 12 | _ | | | |
| t _{AW} | Address Valid to End of Write | 10 | _ | 12 | _ | | | |
| t _{AS} | Address Setup Time | 0 | _ | 0 | _ | ns | | |
| t _{WR} | Write Recovery Time | 0 | _ | 0 | _ | 115 | | |
| t _{DS} | Data Setup Time | 7 | _ | 8 | _ | | | |
| t _{DH} | Data Hold Time | 0 | _ | 0 | _ | | | |
| t _{OEW} | Output Enable Time from Write Enable | 1 | | 1 | | | | |
| t _{ODW} | Output Disable Time from Write Enable | _ | 7 | _ | 8 | | | |

AC TEST CONDITIONS

| PARAMETER | TEST CONDITION |
|--|----------------|
| Input Pulse Level | 3.0 V/ 0.0 V |
| Input Pulse Rise and Fall Time | 2 ns |
| Input Timing Measurement Reference Level | 1.5 V |
| Output Timing Measurement Reference Level | 1.5 V |
| Output Load | Fig.1 |

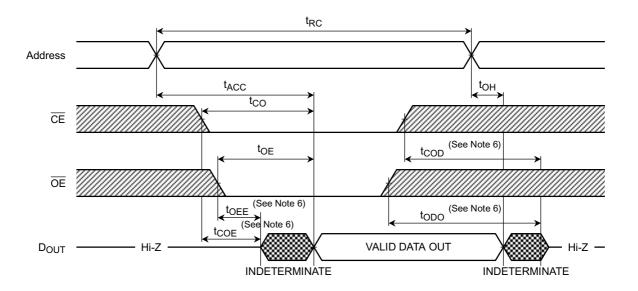
<u>Fig.1</u>



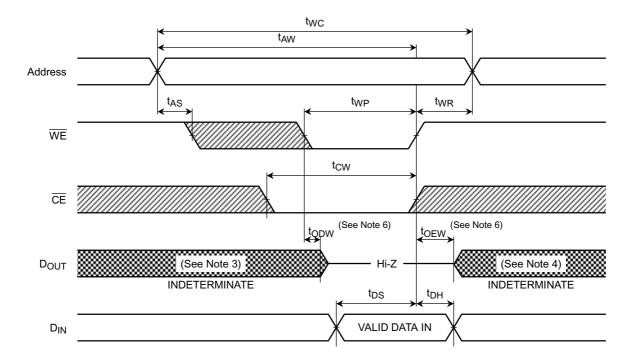


TIMING DIAGRAMS

READ CYCLE (See Note 2)

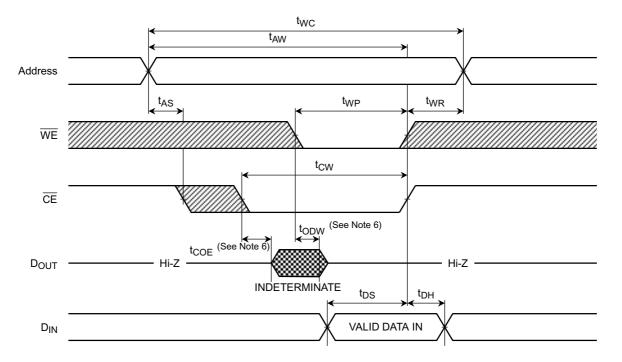


WRITE CYCLE 1 (WE CONTROLLED) (See Note 5)



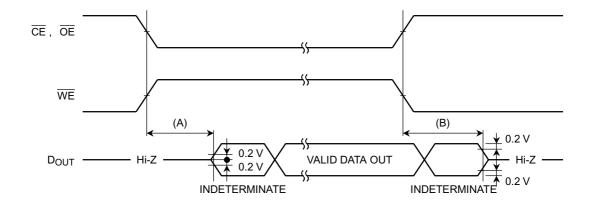


WRITE CYCLE 2 (CE CONTROLLED) (See Note 5)



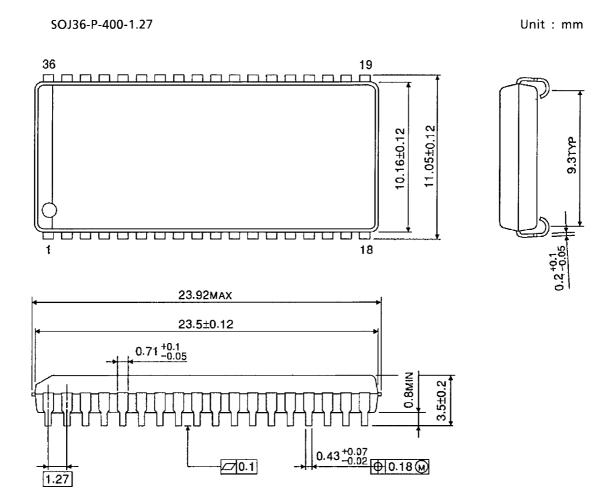
Note:

- (1) Operating temperature (Ta) is guaranteed for transverse air flow exceeding 400 linear feet per minute.
- (2) WE remains HIGH for the Read Cycle.
- (3) If $\overline{\text{CE}}$ goes LOW coincident with or after $\overline{\text{WE}}$ goes LOW, the outputs will remain at high impedance.
- (4) If $\overline{\text{CE}}$ goes HIGH coincident with or before $\overline{\text{WE}}$ goes HIGH, the outputs will remain at high impedance.
- (5) If \overline{OE} is HIGH during the write cycle, the outputs will remain at high impedance.
- (6) The parameters specified below are measured using the load shown in Fig.1.
 - (A) tCOE, tOEE, tOEW · · · · · Output Enable Time
 - (B) t_{COD} , t_{ODO} , t_{ODW} Output Disable Time





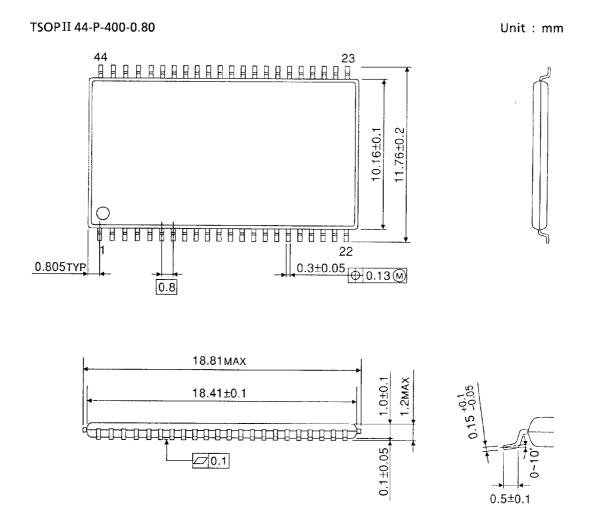
PACKAGE DIMENSIONS



Weight: 1.35 g (typ)



PACKAGE DIMENSIONS



Weight: 0.45 g (typ)

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